

Field-programmable microcontroller peripheral**PSD311**

T-49-19-63

Key Features

- ☐ Single Chip Programmable Peripheral for Microcontroller-based Applications
- ☐ 19 Individually Configurable I/O pins that can be used as:
 - Microcontroller I/O port expansion
 - Programmable Address Decoder (PAD) I/O
 - Latched address output
 - Open drain or CMOS
- ☐ Two Programmable Arrays (PAD A and PAD B)
 - Total of 40 Product Terms and up to 16 Inputs and 24 Outputs
 - Address Decoding up to 1 MB
 - Logic replacement
- ☐ "No Glue" Microcontroller Chip-Set
 - Built-in address latches for multiplexed address/data bus
 - Non-multiplexed address/data bus mode
 - 8-bit data bus width
 - ALE and Reset polarity programmable
 - Selectable modes for read and write control bus as $\overline{RD}/\overline{WR}$ or $R/\overline{W}/\overline{E}$
 - $\overline{PSEN}$ pin for 8051 users
- ☐ 256 Kbits of UV EPROM
 - Configurable as 32K x 8
 - Divides into 8 equal mappable blocks for optimized mapping
 - Block resolution is 4K x 8
 - 120 ns EPROM access time, including input latches and PAD address decoding.
- ☐ 16 Kbit Static RAM
 - Configurable as 2K x 8
 - 120 ns SRAM access time, including input latches and PAD address decoding
- ☐ Address/Data Track Mode
 - Enables easy Interface to Shared Resources (e.g., Mail Box SRAM) with other Microcontrollers or a Host Processor
- ☐ Built-In Security
 - Locks the PSD311 and PAD Decoding Configuration
- ☐ Available in a Choice of Packages
 - 44 Pin PLCC and CLCC
 - 52 Pin PQFP
 - 44 Pin CPGA
- ☐ Simple Menu-Driven Software:
Configure the PSD311 on an IBM PC

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Security Mode

Security Mode in the PSD3XX locks the contents of the PAD A, PAD B and all the configuration bits. The EPROM, SRAM, and I/O contents can be accessed only through the PAD. The Security Mode can be set by the MAPLE or Programming

software. In window packages, the mode is erasable through UV full part erasure. In the security mode, the PSD3XX contents cannot be copied on a programmer.

CMiser-Bit

The CMiser-Bit provides a programmable option for power-sensitive applications that require further reduction in power consumption. The CMiser-Bit (CMiser = 1) in the Maple portion of the PSD3XX system development software can be used to reduce power consumption. The CMiser-Bit turns off the EPROM blocks in the PSD3XX whenever the EPROM is not accessed, thereby reducing the active current consumed by the PSD3XX.

In the default mode, or if the PSD3XX is configured without programming the CMiser-Bit (CMiser = 0), the device operates at specified speed and power rating as specified in the A.C. and D.C. Characteristics.

However, if the CMiser-Bit is programmed (CMiser = 1), the device consumes even lower current, and is reflected in the data sheet. This mode has an added propagation delay in T₅, T₆, and T₇ parameters in the A.C. Characteristics, and should be added to compute worst-case timing requirements in the application.

Absolute Maximum Ratings¹

Symbol	Parameter	Condition	Min	Max	Unit
T _{STG}	Storage Temperature	CERDIP	-65	+150	°C
		PLASTIC	-65	+125	°C
	Voltage on any Pin	With Respect to GND	-0.6	+7	V
V _{PP}	Programming Supply Voltage	With Respect to GND	-0.6	+14	V
V _{CC}	Supply Voltage	With Respect to GND	-0.6	+7	V
	ESD Protection			>2000	V

NOTE: 1. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

Operating Range

Range	Temperature	V _{CC}	V _{CC} Tolerance		
			-12	-15	-20
Commercial	0° C to +70° C	+5 V	±10%	±10%	±10%
Industrial	-40° C to +80° C	+5 V		±10%	±10%
Military	-55° C to +125° C	+5 V			±10%

Recommended Operating Conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	All Speeds	4.5	5	5.5	V
V _{IH}	High-level Input Voltage	V _{CC} = 4.5 V to 5.5 V	2			V
V _{IL}	Low-level Input Voltage	V _{CC} = 4.5 V to 5.5 V	0		0.8	V

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**DC
Characteristics**

Symbol	Parameter	Conditions				CMiser = 1 Subtract:			Unit
			Min	Typ	Max	Min	Typ	Max	
V _{OL}	Output Low Voltage	I _{OL} = 20 μ A V _{CC} = 4.5 V		0.01	0.1				V
		I _{OL} = 8 mA V _{CC} = 4.5 V		0.15	0.45				V
V _{OH}	Output High Voltage	I _{OH} = -20 μ A V _{CC} = 4.5 V	4.4	4.49					V
		I _{OH} = -2 mA V _{CC} = 4.5 V	2.4	3.9					V
I _{SB1}	V _{CC} Standby Current (CMOS) (Notes 2 and 4)	Comm'l		50	100				μ A
		Ind/Mil		75	150				μ A
I _{CC1}	Active Current (CMOS) (No Internal Memory Block Selected) (Notes 2 and 5)	Comm'l (Note 6)		16	35		7	10	mA
		Comm'l (Note 7)		28	50		7	10	mA
		Ind/Mil (Note 6)		16	45		7	10	mA
		Ind/Mil (Note 7)		28	60		7	10	mA
I _{CC2}	Active Current (CMOS) (EPROM Block Selected) (Notes 2 and 5)	Comm'l (Note 6)		16	35		0	0	mA
		Comm'l (Note 7)		28	50		0	0	mA
		Ind/Mil (Note 6)		16	45		0	0	mA
		Ind/Mil (Note 7)		28	60		0	0	mA
I _{CC3}	Active Current (CMOS) (SRAM Block Selected) (Notes 2 and 5)	Comm'l (Note 6)		47	80		7	10	mA
		Comm'l (Note 7)		59	95		7	10	mA
		Ind/Mil (Note 6)		47	100		7	10	mA
		Ind/Mil (Note 7)		59	115		7	10	mA
I _{LI}	Input Leakage Current	V _{IN} = 5.5 V or GND	-1	± 0.1	1				μ A
I _{LO}	Output Leakage Current	V _{OUT} = 5.5 V or GND	-10	± 5	10				μ A

NOTES: 2. CMOS inputs: GND $\pm$ 0.3 V or V_{CC} $\pm$ 0.3V.3. TTL inputs: V_{IL} $\leq$ 0.8 V, V_{IH} $\geq$ 2.0 V.

4. CS1/A19 is high and the part is in a power-down configuration mode.

5. Add 3.0 mA/MHz for AC power component (power = AC + DC).

6. Ten (10) PAD product terms active. (Add 380 μ A per product term, typical, or 480 μ A per product term maximum)

7. Forty-one (41) PAD product terms active.

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AC Characteristics

Symbol	Parameter	-90		-12		-15		-20		CMiser = 1 Add:	Unit
		Min	Max	Min	Max	Min	Max	Min	Max		
T1	ALE or AS Pulse Width	20		30		40		50		0	ns
T2	Address Set-up Time	5		9		12		15		0	ns
T3	Address Hold Time	8		13		15		25		0	ns
T4	Leading Edge of Read to Data Active	0		0		0		0		0	ns
T5	ALE Valid to Data Valid		100		140		170		200	10	ns
T6	Address Valid to Data Valid		90		120		150		200	10	ns
T7	$\overline{\text{CS}}$ Active to Data Valid		100		150		160		200	15	ns
T8	Leading Edge of Read to Data Valid		32		38		55		60	0	ns
T9	Read Data Hold Time	0		0		0		0		0	ns
T10	Trailing Edge of Read to Data High-Z		35		35		40		45	0	ns
T11	Trailing Edge of ALE or AS to Leading Edge of Write	0		0		0		0		0	ns
T12	$\overline{\text{RD}}$, $\overline{\text{E}}$, $\overline{\text{PSEN}}$, or $\overline{\text{DS}}$ Pulse Width	40		45		60		75		0	ns
T12A	$\overline{\text{WR}}$ Pulse Width	20		25		35		45		0	ns
T13	Trailing Edge of Write or Read to Leading Edge of ALE or AS	0		0		0		0		0	ns
T14	Address Valid to Trailing Edge of Write	90		120		150		200		0	ns
T15	$\overline{\text{CS}}$ Active to Trailing Edge of Write	100		130		160		200		0	ns
T16	Write Data Set-up Time	20		25		30		40		0	ns
T17	Write Data Hold Time	5		5		10		15		0	ns
T18	Port to Data Out Valid Propagation Delay		30		30		35		45	0	ns
T19	Port Input Hold Time	0		0		0		0		0	ns
T20	Trailing Edge of Write to Port Output Valid	40		40		50		60		0	ns
T21	ADi or Control to $\overline{\text{CS}}$ Valid	6	25	6	30	6	35	5	45	0	ns
T22	ADi or Control to $\overline{\text{CS}}$ Invalid	5	25	5	30	4	35	4	45	0	ns

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AC Characteristics (Cont.)

Symbol	Parameter	-90		-12		-15		-20		CMiser = 1 Add:*	Unit
		Min	Max	Min	Max	Min	Max	Min	Max		
T23	Track Mode Address Propagation Delay: CSADOUT1 Already True		22		22		22		28	0	ns
T23A	Track Mode Address Propagation Delay: CSADOUT1 Becomes True During ALE or AS		33		33		40		50	0	ns
T24	Track Mode Trailing Edge of ALE or AS to Address High-Z		32		32		35		40	0	ns
T25	Track Mode Read Propagation Delay		29		29		29		35	0	ns
T26	Track Mode Read Hold Time	11	29	11	29	10	29	10	35	0	ns
T27	Track Mode Write Cycle, Data Propagation Delay		20		20		20		30	0	ns
T28	Track Mode Write Cycle, Write to Data Propagation Delay	8	30	8	30	7	40	7	55	0	ns
T29	Hold Time of Port A Valid During Write CSOi Trailing Edge	2		2		2		2		0	ns
T30	CSi Active to CSOi Active	9	40	9	45	9	45	8	60	0	ns
T31	CSi Inactive to CSOi Inactive	9	40	9	45	9	45	8	60	0	ns
T32	Direct PAD Input as Hold Time	10		10		12		15		0	ns
T33	R/W Active to E High	20		20		30		40		0	ns
T34	E End to R/W	20		20		30		40		0	ns
T35	AS Inactive to E high	0		0		0		0		0	ns
T36	Address to Leading Edge of Write	20		20		25		30		0	ns

NOTES: 8. ADi = any address line.

9. CSOi = any of the chip-select output signals coming through Port B (CS0–CS7) or through Port C (CS8–CS10).

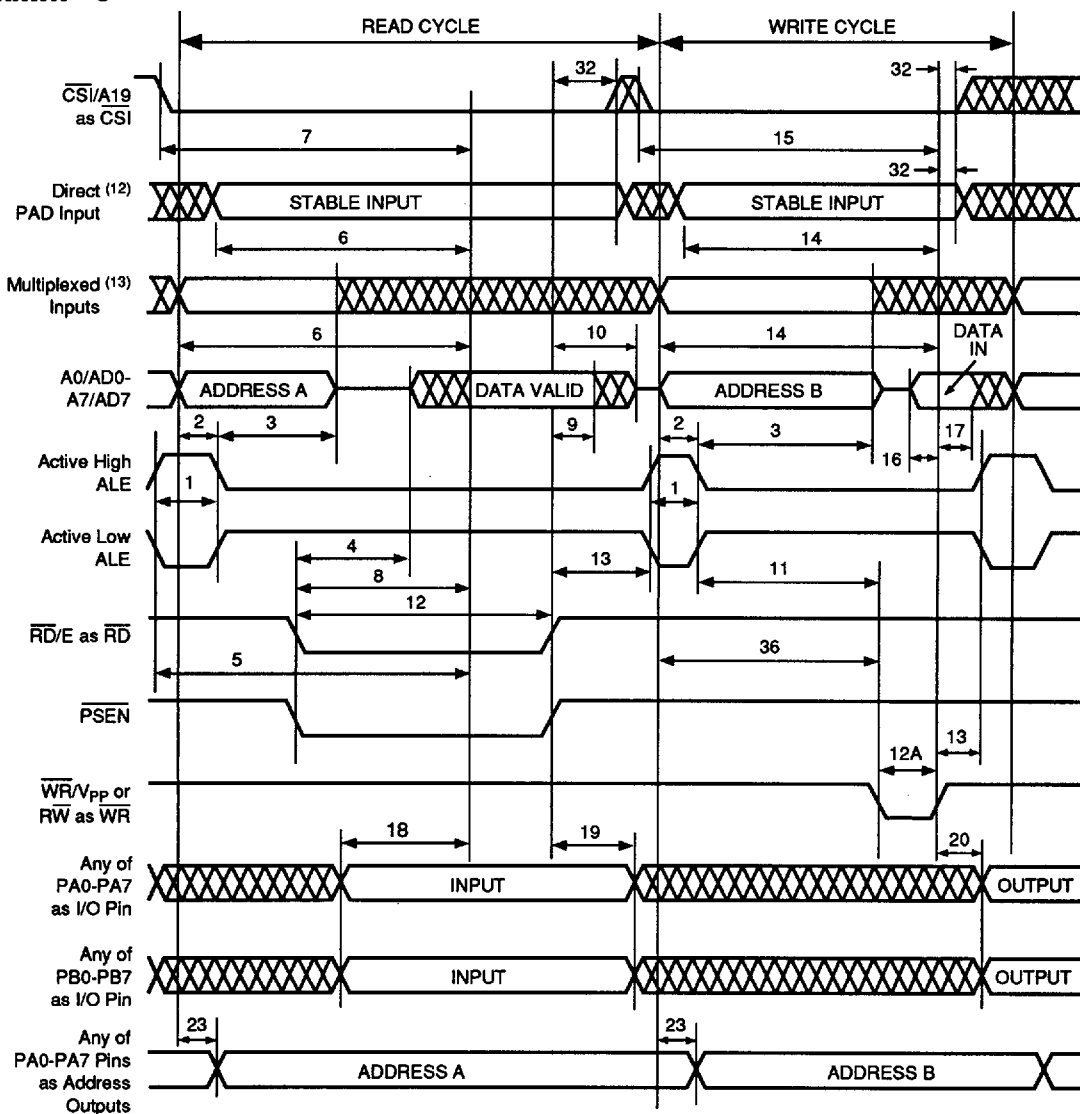
10. Direct PAD input = any of the following direct PAD input lines: CSi/A19 as transparent A19, RD/E/DS, WR or R/W, transparent PC0–PC2, ALE (or AS).

11. Control signals RD/E/DS or WR or R/W.

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Figure 1.
Timing of 8-Bit
Multiplexed
Address/DataBus,
CRRWR = 0

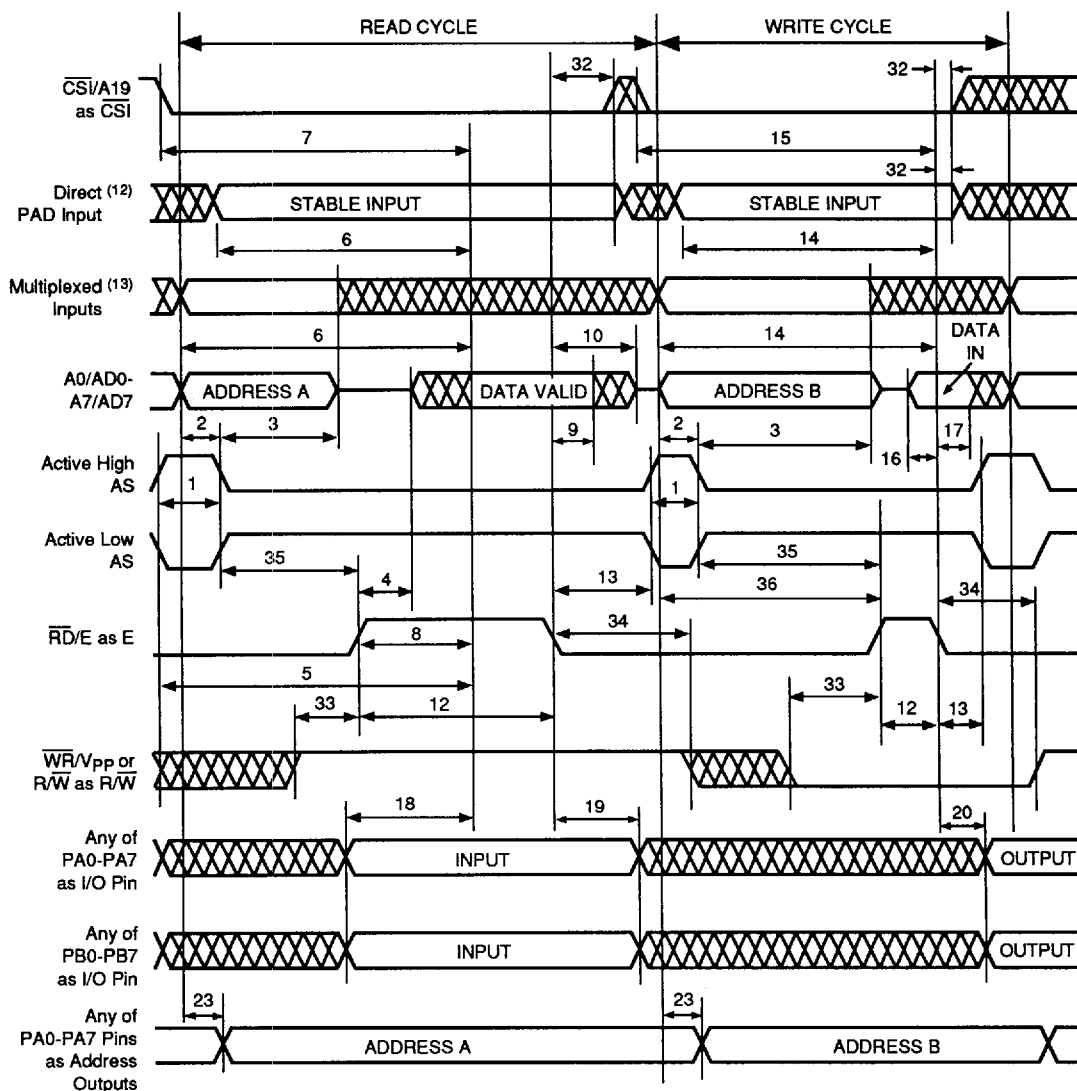


See referenced notes on page 66.

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Figure 2.
Timing of 8-Bit
Multiplexed
Address/DataBus,
CRRWR = 1

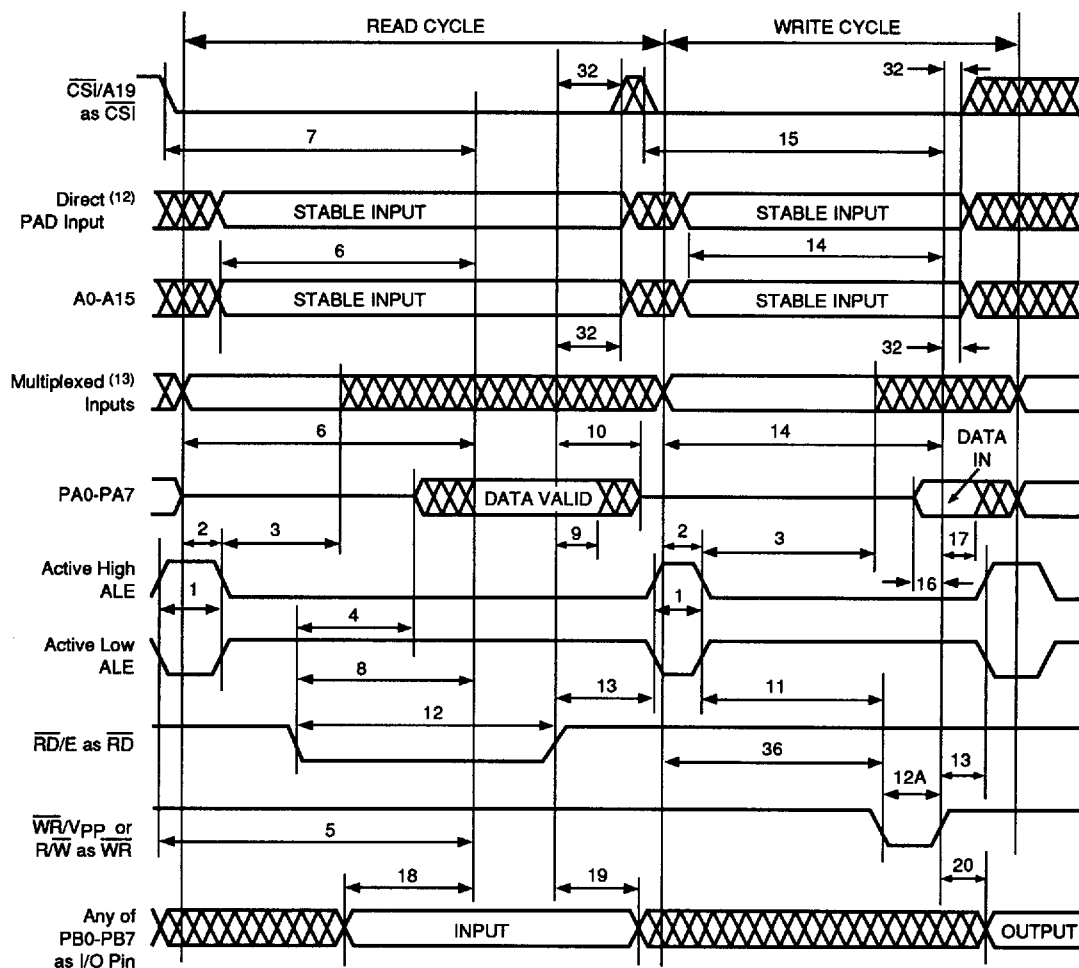


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Figure 3.
Timing of 8-Bit Data,
Non-Multiplexed
Address/DataBus,
CRRWR = 0

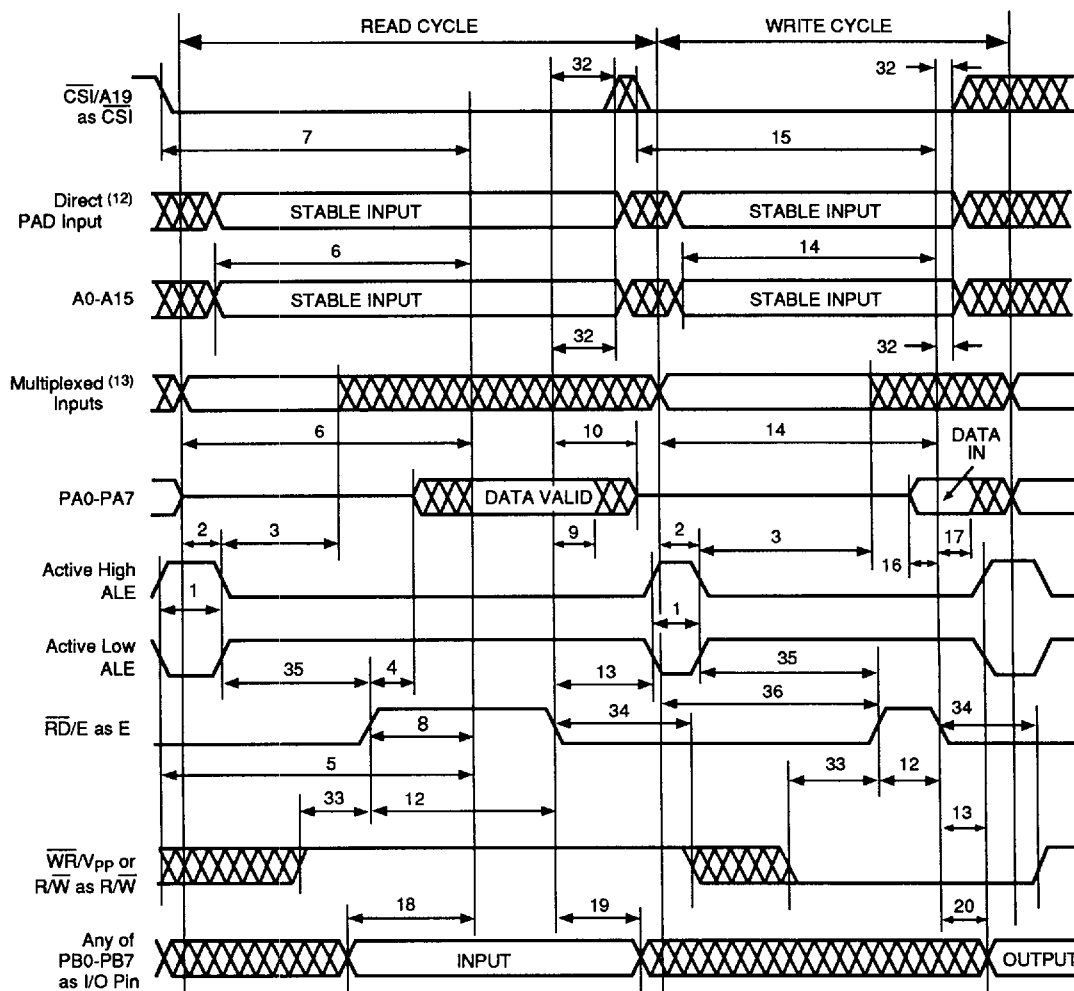


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Figure 4.
Timing of 8-Bit Data,
Non-Multiplexed
Address/DataBus,
CRRWR = 1

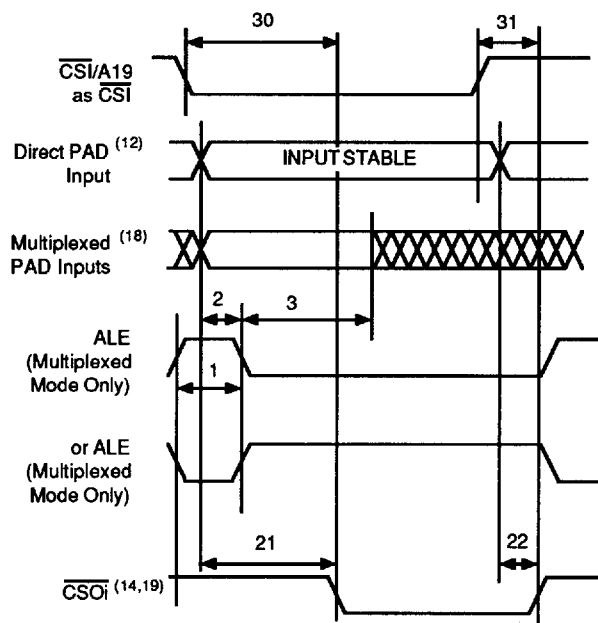


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Figure 5.
Chip-Select
Output Timing

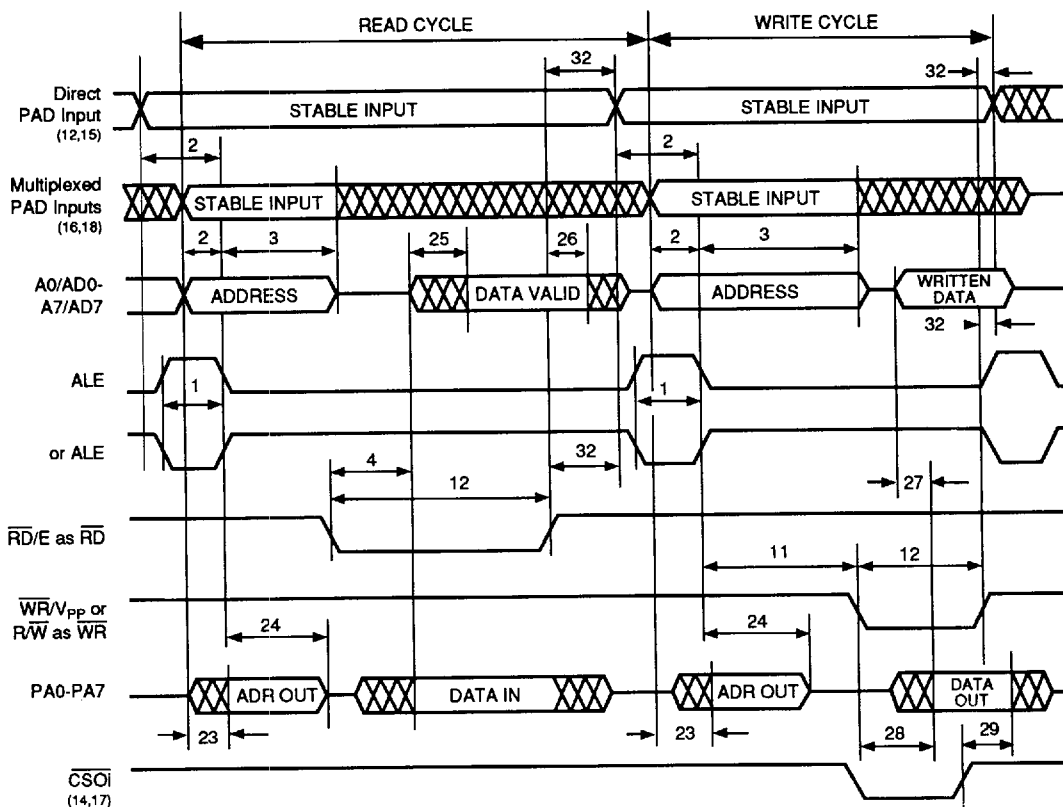


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Figure 6.
Port A
as AD0-AD7 Timing
(Track Mode),
CRRWR = 0

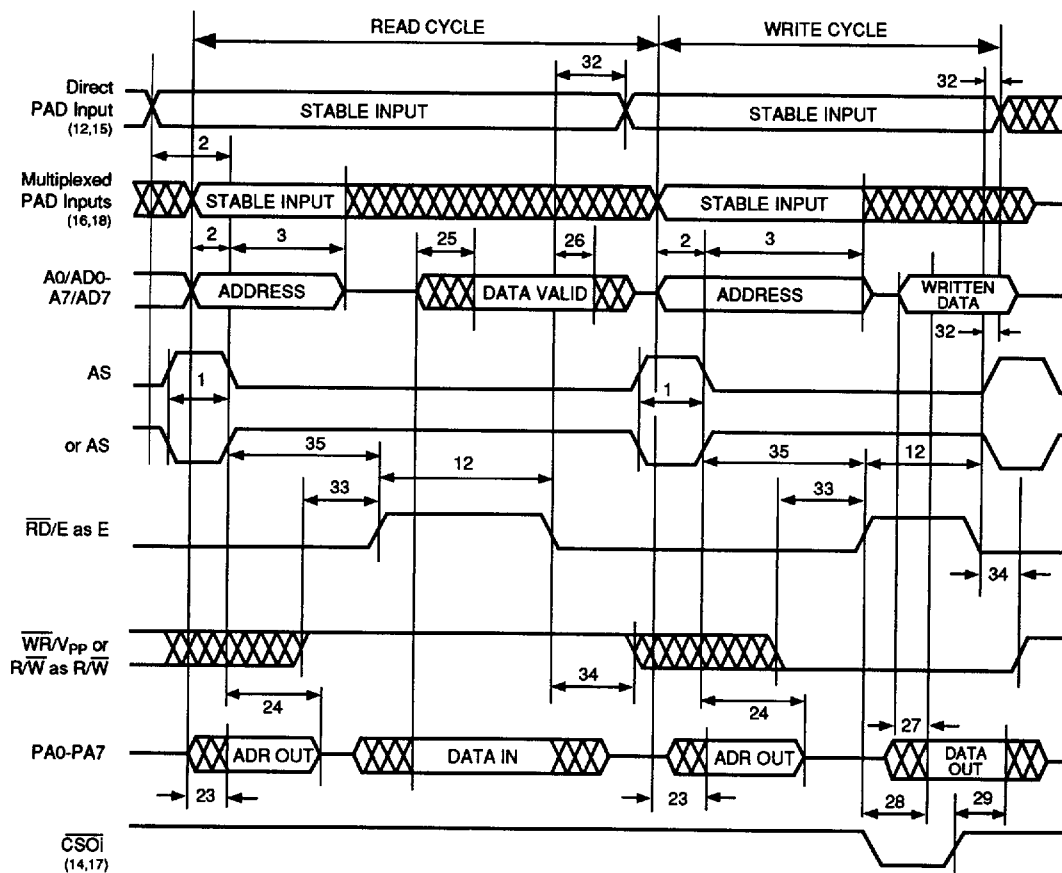


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Figure 7. Port A as ADO-AD7 Timing
(Track Mode), $CRRWR = 1$



**Notes for
Timing
Diagrams**

12. Direct PAD input = any of the following direct PAD input lines: $\overline{CSi}/A19$ as transparent A19, RD/E, WR or R/W, transparent PC0-PC2, ALE in non-multiplexed modes.
13. Multiplexed inputs: any of the following inputs that are latched by the ALE (or AS): A0/ADO-A15/AD15, $\overline{CSi}/A19$ as ALE dependent A19, ALE dependent PC0-PC2.
14. $\overline{CS0i}$ = any of the chip-select output signals coming through Port B ($\overline{CS0}-\overline{CS7}$) or through Port C ($\overline{CS8}-\overline{CS10}$).
15. CSADOUT1, which internally enables the address transfer to Port A, should be derived only from direct PAD input signals, otherwise the address propagation delay is slowed down.
16. CSADIN and CSADOUT2, which internally enable the data-in or data-out transfers, respectively, can be derived from any combination of direct PAD inputs and multiplexed PAD inputs.
17. The write operation signals are included in the $\overline{CS0i}$ expression.
18. Multiplexed PAD inputs: any of the following PAD inputs that are latched by the ALE (or AS) in the multiplexed modes: A11/AD11-A15/AD15, $\overline{CSi}/A19$ as ALE dependent A19, ALE dependent PC0-PC2.
19. $\overline{CS0i}$ product terms can include any of the PAD input signals except for reset and $\overline{CSi}$.

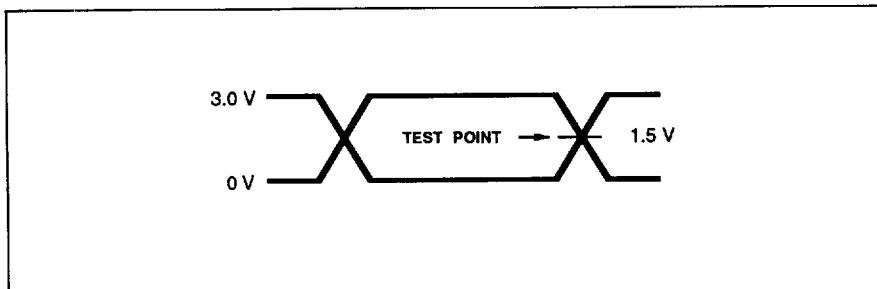
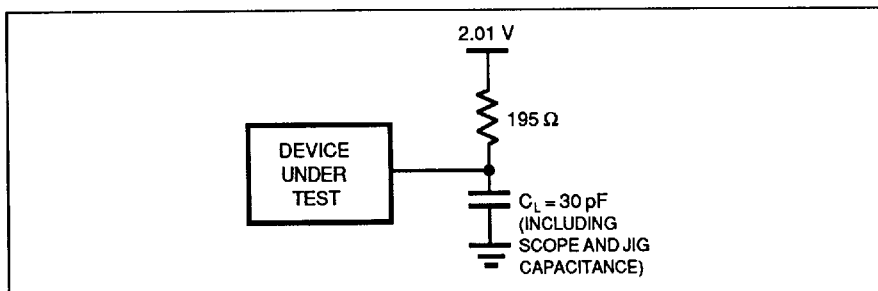
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Pin Capacitance²⁰

Symbol	Parameter	Conditions	Typical ²¹	Max	Unit
C _{IN}	Capacitance (for input pins only)	V _{IN} = 0 V	4	6	pF
C _{OUT}	Capacitance (for input/output pins)	V _{OUT} = 0 V	8	12	pF
C _{VPP}	Capacitance (for WR/V _{PP} or R/W/V _{PP})	V _{PP} = 0 V	18	25	pF

NOTES: 20. This parameter is only sampled and is not 100% tested.

21. Typical values are for T_A = 25°C and nominal supply voltages.**Figure 8.
AC Testing
Input/Output
Waveform****Figure 9.
AC Testing
Load Circuit****Erase and
Programming**

To clear all locations of their programmed contents, expose the device to ultra-violet light source. A dosage of 15 W second/cm² is required. This dosage can be obtained with exposure to a wavelength of 2537 Å and intensity of 12000 μW/cm² for 15 to 20 minutes. The device should be about 1 inch from the source, and all filters should be removed from the UV light source prior to erasure.

The PSD3XX and similar devices will erase with light sources having wavelengths shorter than 4000 Å. Although the erasure times will be much longer than with UV sources at 2537 Å, exposure to fluorescent light and sunlight eventually erases the

device. For maximum system reliability, these sources should be avoided. If used in such an environment, the package windows should be covered by an opaque substance.

Upon delivery, or after each erasure, the PSD3XX device has all bits in the PAD and EPROM in the "1" or high state. The configuration bits are in the "0" or low state. The code, configuration, and PAD MAP data are loaded through the procedure of programming

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**Pin
Assignments**

Pin Name	44-Pin PLCC/CLCC Package	52-Pin PQFP Package
PSEN	1	46
WR/V _{PP} or R/W	2	47
RESET	3	48
PB7	4	49
PB6	5	50
PB5	6	51
PB4	7	2
PB3	8	3
PB2	9	4
PB1	10	5
PB0	11	6
GND	12	7
ALE or AS	13	8
PA7	14	9
PA6	15	10
PA5	16	11
PA4	17	12
PA3	18	15
PA2	19	16
PA1	20	17
PA0	21	18
RD/E	22	19
AD0/A0	23	20
AD1/A1	24	21
AD2/A2	25	22
AD3/A3	26	23
AD4/A4	27	24
AD5/A5	28	25
AD6/A6	29	28
AD7/A7	30	29
A8	31	30
A9	32	31
A10	33	32
GND	34	33
A11	35	34
A12	36	35
A13	37	36
A14	38	37
A15	39	38
PC0	40	41
PC1	41	42
PC2	42	43
A19/CS1	43	44
V _{CC}	44	45

NOTE: 36. Pins 1, 13, 14, 26, 27, 39, 40, and 52 are No Connect.

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Package Information

Figure 10.
Drawing L4 –
44 Pin Ceramic
Leaded Chip
Carrier (CLCC)
with Window
(Package Type L)

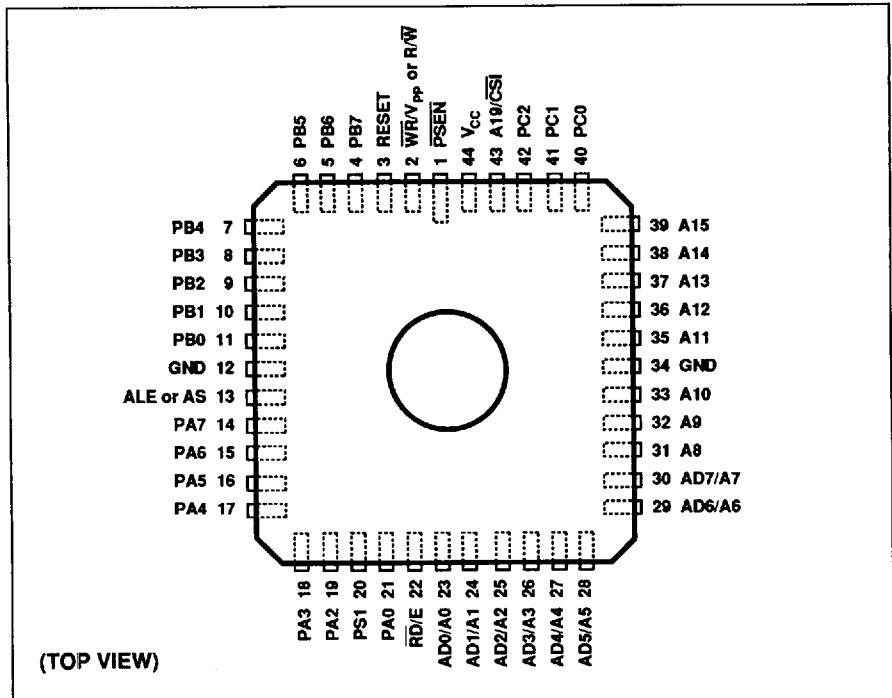
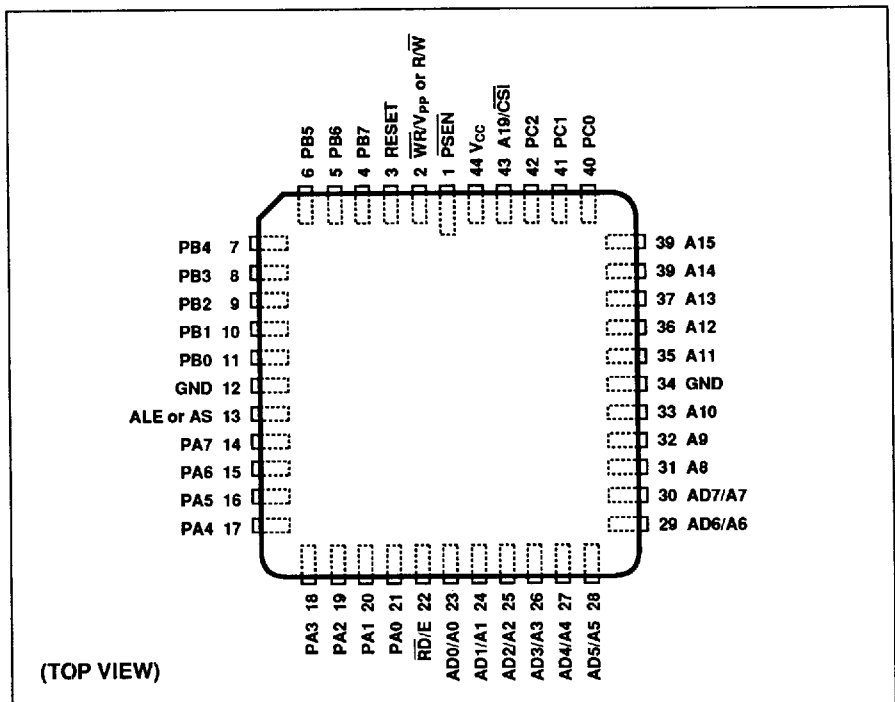


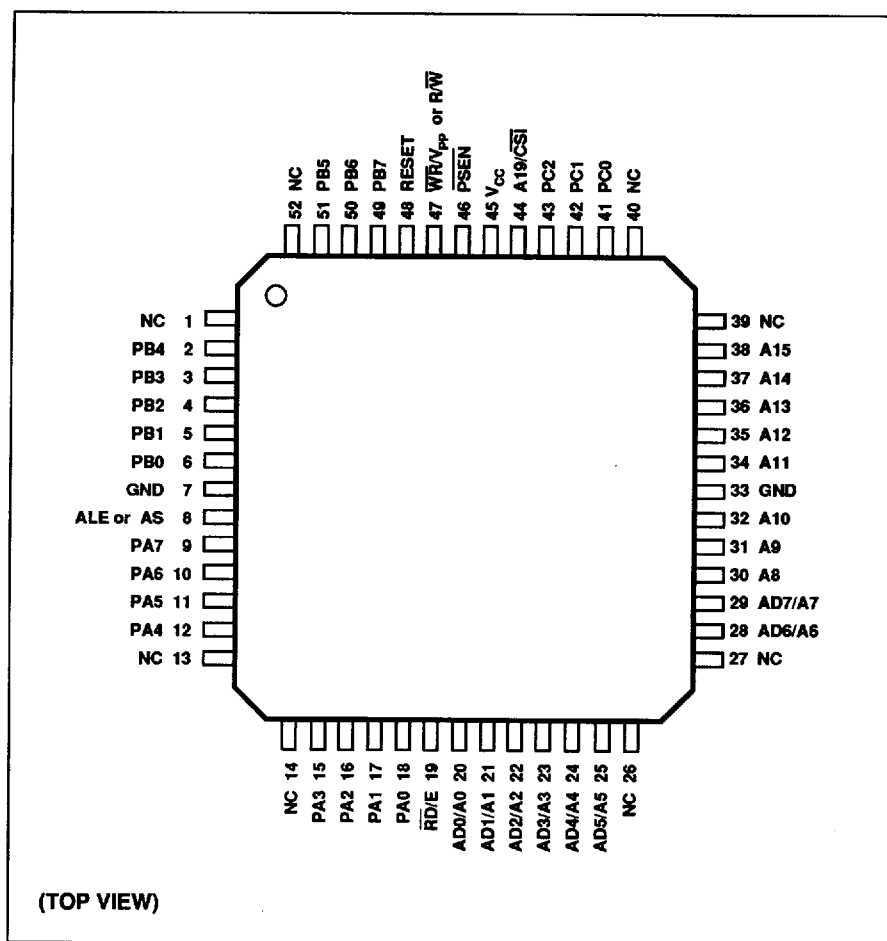
Figure 11.
Drawing J2 –
44 Pin Plastic
Leaded Chip
Carrier (PLCC)
(Package Type J)



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Figure 12.
Drawing Q2 –
52 Pin PQFP
(Package Type Q)



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**Ordering
Information**

<i>Part Number</i>	<i>Spd. (ns)</i>	<i>Package Type</i>	<i>Package Drawing</i>	<i>Operating Temperature Range</i>	<i>Manufacturing Procedure</i>
PSD311-90 A	90	44-pin PLCC	J2	Commercial	Standard
PSD311-90 KA	90	44-pin CLCC	L4	Commercial	Standard
PSD311-12 A	120	44-pin PLCC	J2	Commercial	Standard
PSD311-12 KA	120	44-pin CLCC	L4	Commercial	Standard
PSD311-12 B	120	52-pin PQFP	Q2	Commercial	Standard
PSD311-15 A	150	44-pin PLCC	J2	Commercial	Standard
PSD311-15I A	150	44-pin PLCC	J2	Industrial	Standard
PSD311-15 KA	150	44-pin CLCC	L4	Commercial	Standard
PSD311-15I KA	150	44-pin CLCC	L4	Industrial	Standard
PSD311-15 B	150	52-pin PQFP	Q2	Commercial	Standard
PSD311-15I B	150	52-pin PQFP	Q2	Industrial	Standard
PSD311-20 A	200	44-pin PLCC	J2	Commercial	Standard
PSD311-20I A	200	44-pin PLCC	J2	Industrial	Standard
PSD311-20 KA	200	44-pin CLCC	L4	Commercial	Standard
PSD311-20I KA	200	44-pin CLCC	L4	Industrial	Standard
PSD311-20 B	200	52-pin PQFP	Q2	Commercial	Standard
PSD311-20I B	200	52-pin PQFP	Q2	Industrial	Standard